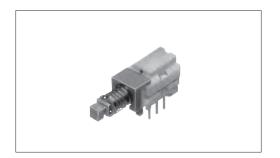
## Horizontal type suitable for multiple circuits





#### Typical Specifications

Ite	ms	Specifications	
Rating (max.)/(mi (Resistive load)	n.)	0.1A 30V DC / 50 μA 3V DC	
Contact resistand (Initial/After opera	~	$20$ m $\Omega$ max. / $40$ m $\Omega$ max.	
Operating forces	2-pole	1.5±1N	
Operating forces	4-pole	2.3±1N	
Operating life	Without load	10,000 cycles	
Operating life	With load	10,000 cycles (0.1A 30V DC)	

#### Product Line

Changeover	Travel	Total travel	Mounting		Poles Operation	Terminal	Minimum ord	er unit (pcs.)	Product No.
timing	(mm)	(mm)	method	. 0.00		type	Japan	Export	110000110.
Non shorting 2 3						Straight			SPUJ190900
			2	Latching	Snap-in	000	0.000	SPUJ191000	
		2 3	PC board		Momentary -	Straight	600	3,000	SPUJ191500
	2					Snap-in			SPUJ191900
			Latching	Straight			SPUJ193700		
				4	Latering	Snap-in	400	2,000	SPUJ193900
					Momentary	Straight			SPUJ194500

#### Packing Specifications

Bulk

Product No.	Number of pa	Export package measurements (mm)		
	1 case / Japan 1 case / export packing			
SPUJ190900, SPUJ191000, SPUJ191500, SPUJ191900	600	3,000	400,4070,4000	
SPUJ193700, SPUJ193900, SPUJ194500	400	2,000	400×270×290	

Style

PC board mounting hole dimensions (Viewed from the direction A)

2-pole, 4-pole

Straight terminal

Snap-in terminal

Snap-in terminal

PC board mounting face

PC board mounting hole dimensions (Viewed from the direction A)

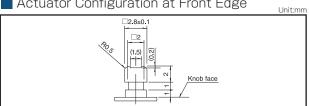
Snap-in terminal

Formal Snap-in terminal

Snap-in terminal

PC board mounting face

Actuator Configuration at Front Edge



■ Circuit Diagram (Viewed from Direction A)

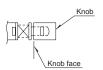
2-pole	4-pole	7-11-1
(4)——(1) (5)——(2) (6)——(3)		8 —

■ Knob Lineup

TOOD EITICOP		Unit:mm
Knob outline drawing		Model
4.6	Color:Black	UJ206022

### Notes

We recommend the use of adhesive to secure the knob when mounting onto switches.



					Horizontal			
	Series		SPPJ3	SPPJ2	SPUJ	SPUN	SPUN medium current	
	Photo			M A				
W		5 or 6.6	7.2	7.5 10		10		
Dimensio (mm)			1	2	15.2 22.7	24 36		
			8.3	9.6	8.8	13		
Tra	vel (mm)		2	.5	2	2	2.5	
Total -	travel (m	m)	3	.5	3	3	3.5	
Numb	er of pole	es	1 2	2		2 4		
	perating rature rar	nge	-40℃ to +85℃		−10°C to	0 +60℃		
Autor	motive us	se	•	•	_			
Lit	fe cycle		<b>★</b> 3	*3	★3	<b>★</b> 3		
Rating (max.) 0.2A 30V DC (Resistive load)			BOV DC	0.1A 30V DC 1A 25V DC				
Rating (min.) (Resistive load) 50 $\mu$ A 3V DC				_				
Durability	Operat withou	ing life It load	10	10,000 cycles 40mΩ max. 30,000 cycles 40mΩ max.			10,000 cycles 40mΩ max.	
Durability	Operating li (at max. r		10,000 cycles $40\text{m}\Omega$ max.				5,000 cycles 40mΩ max.	
	Initial c resist	ontact tance			20mΩ max.			
Electrical performance	Insul resist	ation tance	100MΩ min. 500V DC					
	Voltag	e proof			500V AC for 1minute			
	Tern stre	ninal ngth			5N for 1minute			
Mechanical performance	Actuator	Operating direction	50N	30N		50N		
	strength	Pulling direction	_	_		50N		
Cold −40°C 96h			-20°C	-20℃ 96h				
Environmental performance	Dry heat		85°C 96h					
	Damp	heat	40°C, 90 to 95%RH 96h					
	Page		111	113	115	1	17	

#### Note

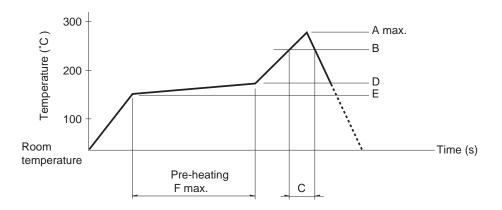
• Indicates applicability to all products in the series.

### ■ Example of Reflow Soldering Condition

- 1. Heating method: Double heating method with infrared heater.
- 2. Temperature measurement: Thermocouple  $\phi$  0.1 to 0.2 CA (K) or CC (T) at soldering portion (copper foil surface). A heat resisting tape should be used for fixed measurement.

Push Switches / Soldering Conditions

3. Temperature profile



Series (Reflow type)	A (°C) 3s max.	B (℃)	C (s)	D (℃)	E (℃)	F (s)
SPEJ						
SPEF	260	230	40	180	150	120
SPEH						

#### Notes

- 1. The condition mentioned above is the temperature on the mounting surface of a PC board. There are cases where the PC board's temperature greatly differs from that of the switch, depending on the PC board's material, size, thickness, etc.

  The above-stated conditions shall also apply to switch surface temperatures.
- 2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

#### ■ Reference for Hand Soldering

Series	Soldering temperature	Soldering time	
SPPJ3, SPPJ2, SPUN, SPUJ, SPPH4, SPPH1	350±10℃	3+1/0s	
SPED2, SPED4	350±10℃	3±0.5s	
SPEJ	350±10°C	4s max.	
SPEF	350±5℃	3s max.	
SPEH	350℃ max.	3s max.	

#### Reference for Dip Soldering

(For PC board terminal types)

Series	Ite	ms	Dip soldering		
Jelles	Preheating temperature	Preheating time	Soldering temperature	Duration of immersion	
SPPJ3	100℃ max.	60s max.	260±5℃	5±1s	
SPUN	100℃ max.	60s max.	260±5℃	10±1s	
SPUJ, SPPH4	_		260±5℃	5±1s	
SPPJ2, SPPH1, SPED2, SPED4, SPEF	_		260±5℃	10±1s	

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

## Alps Alpine:

SPUJ193900 SPUJ190900 SPUJ193700 SPUJ194500 SPUJ191500 SPUJ191900 SPUJ191000